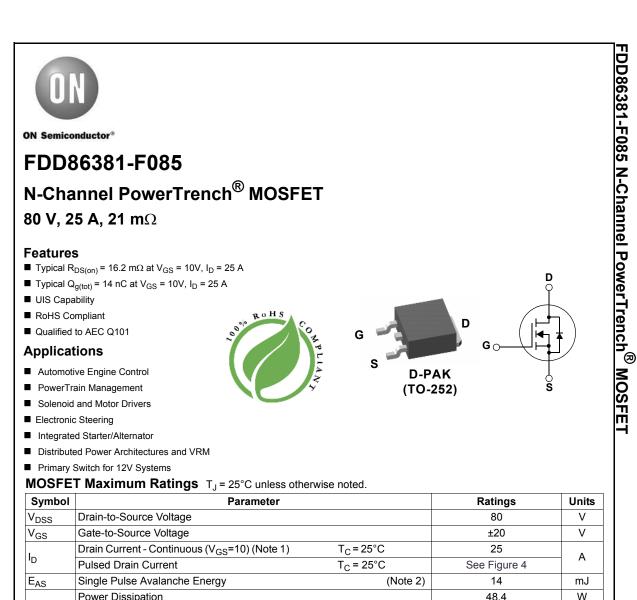
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р	Power Dissipation
۳D	Derate Above 25°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature
$R_{\theta JC}$	Thermal Resistance, Junction to Case

Maximum Thermal Resistance, Junction to Ambient

Notes:

 $R_{\theta JA}$ 

1: Current is limited by bondwire configuration.

2: Starting  $T_J = 25^{\circ}$ C, L = 70 $\mu$ H,  $I_{AS} = 20$ A,  $V_{DD} = 80$ V during inductor charging and  $V_{DD} = 0$ V during time in avalanche.

3: R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design, while R<sub>0JA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86381	FDD86381-F085	D-PAK(TO-252)	13"	16mm	2500units

W/ºC °C

°C/W

°C/W

0.323

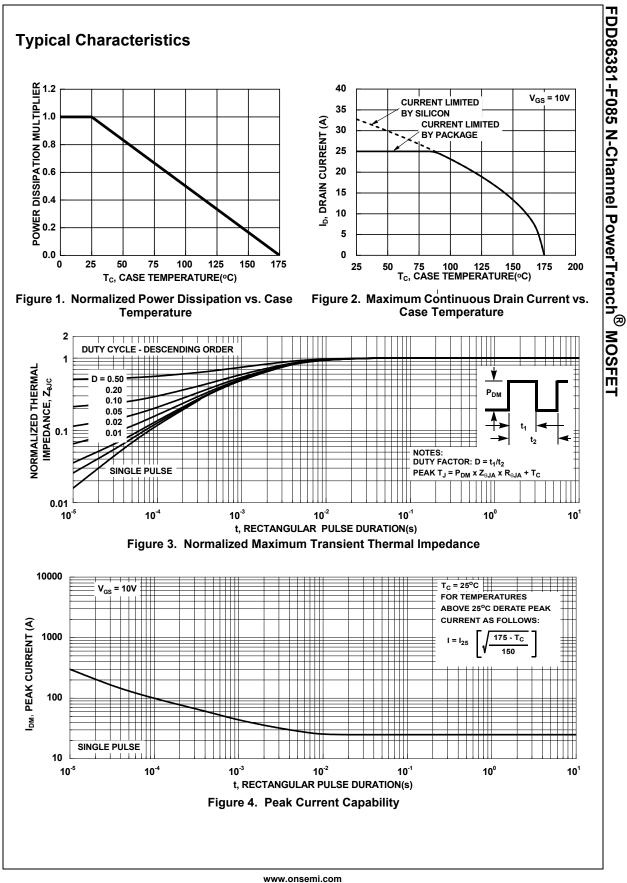
-55 to + 175

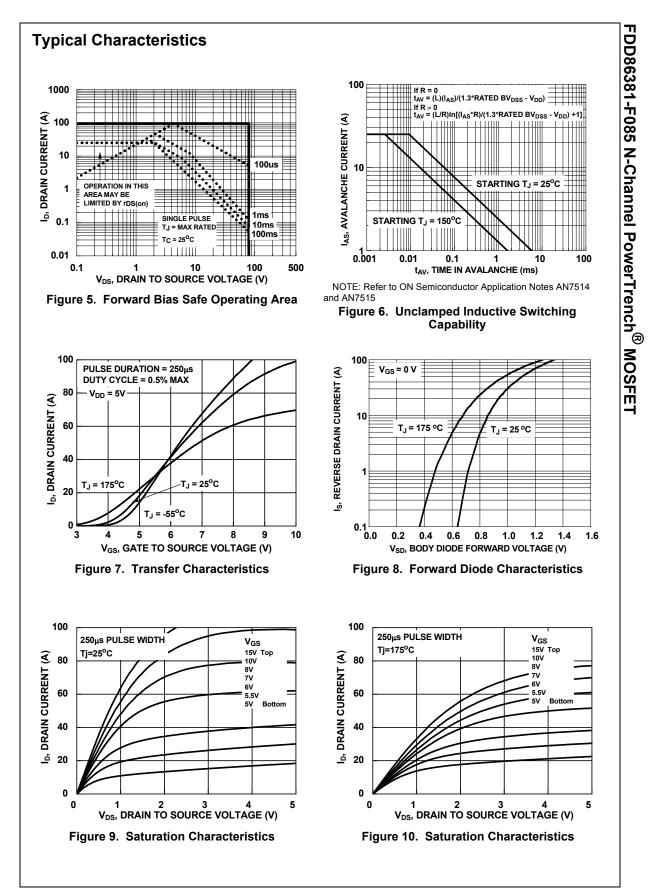
3.1

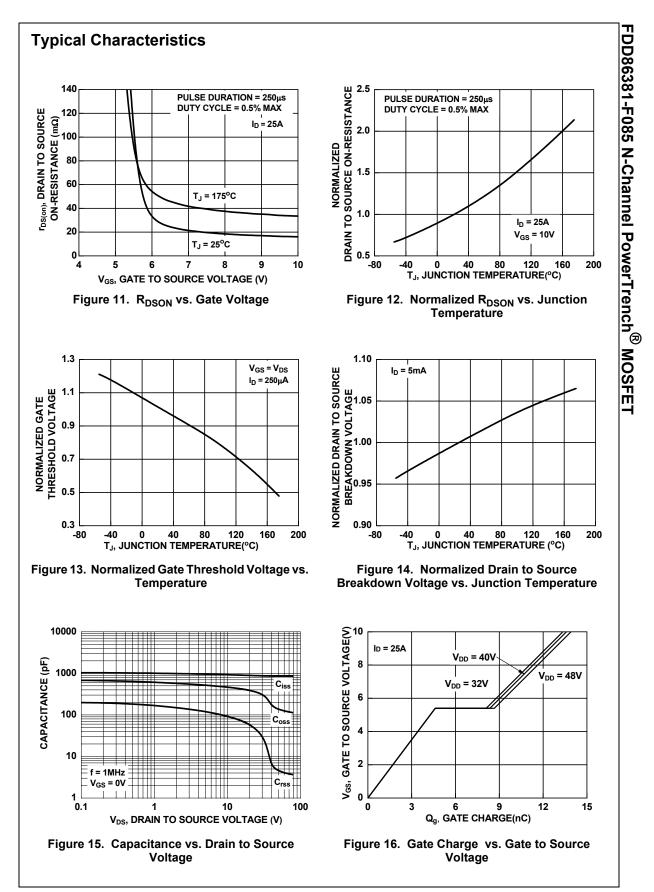
52

(Note 3)

	Parameter Test Conditions		Min.	Тур.	Max.	Units	
Off Cha	aracteristics	L					
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V		80	-	-	V
	Drain-to-Source Leakage Current	$V_{DS}$ =80V, $T_{J}$ = 25°C		-	-	1	μA
IDSS	Drain-to-obdice Leakage Ourient		$T_{\rm J}$ = 175°C (Note 4)	-	-	1	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$ ,	l <sub>D</sub> = 250μA	2.0	2.7	4.0	V
_	Drain to Source On Registence	I <sub>D</sub> = 25A,	$T_J = 25^{\circ}C$	-	16.2	21	mΩ
R <sub>DS(on)</sub>	Drain to Source On Resistance	V <sub>GS</sub> = 10V	T <sub>J</sub> = 175 <sup>o</sup> C (Note 4)	-	34.7	45	mΩ
Dynami	ic Characteristics						
C <sub>iss</sub>	Input Capacitance	$\gamma = 40\gamma$	( - 0)(	-	866	-	pF
C <sub>oss</sub>	Output Capacitance	− V <sub>DS</sub> = 40V, V f = 1MHz	v <sub>GS</sub> = 0V,	-	176	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			-	7	-	pF
R <sub>g</sub>	Gate Resistance	$V_{GS} = 0.5 V,$	f = 1MHz	-	2.3	-	Ω
Q <sub>g(ToT)</sub>	Total Gate Charge	V <sub>GS</sub> = 0 to 1	0V V <sub>DD</sub> = 40V	-	14	21	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	V <sub>GS</sub> = 0 to 2	V I <sub>D</sub> = 25A	-	1.6	-	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge			-	5	-	nC
Q <sub>gd</sub>	Gate-to-Drain "Miller" Charge			-	4	-	nC
	ng Characteristics				1	05	
t <sub>on</sub>	Turn-On Time		-	-	-	25	ns
	Turn-On Delay			-	8	-	ns
t <sub>d(on)</sub>	Rise Time	$V_{DD} = 40V, I_D = 25A,$		-	9	-	ns
t <sub>d(on)</sub> t <sub>r</sub>			$V_{GS}$ = 10V, $R_{GEN}$ = 6 $\Omega$		14	-	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-Off Delay	V <sub>GS</sub> = 10V,	R <sub>GEN</sub> – 052		-		
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub>	Turn-Off Delay Fall Time	V <sub>GS</sub> = 10V,	R <sub>GEN</sub> - 052	-	5	-	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub>	Turn-Off Delay	V <sub>GS</sub> = 10V,	r <sub>GEN</sub> – 012	-	5	- 28	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>off</sub>	Turn-Off Delay Fall Time	V <sub>GS</sub> = 10V,	r <sub>GEN</sub> - 052				-
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>off</sub> <b>Drain-S</b>	Turn-Off Delay Fall Time Turn-Off Time cource Diode Characteristics	I <sub>SD</sub> = 25A, \	/ <sub>GS</sub> = 0V			28 1.25	ns V
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>off</sub> <b>Drain-S</b>	Turn-Off Delay   Fall Time   Turn-Off Time   cource Diode Characteristics   Source-to-Drain Diode Voltage	I <sub>SD</sub> = 25A, V I <sub>SD</sub> = 12.5A	/ <sub>GS</sub> = 0V V <sub>GS</sub> = 0V		-	28	ns
t <sub>d(on)</sub> t <sub>r</sub> t <sub>d(off)</sub> t <sub>f</sub> t <sub>off</sub>	Turn-Off Delay Fall Time Turn-Off Time cource Diode Characteristics	I <sub>SD</sub> = 25A, \	/ <sub>GS</sub> = 0V , V <sub>GS</sub> = 0V I <sub>F</sub> = 25A,		-	28 1.25	ns V







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